

HAT2240C

Silicon N Channel MOS FET Power Switching

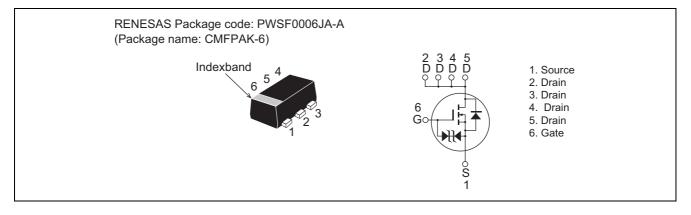
> REJ03G1241-0400 Rev.4.00 Apr 05, 2006

> > $(\mathbf{T}_{0} - 25^{\circ}\mathbf{C})$

Features

- Low on-resistance $R_{DS(on)} = 75 \text{ m}\Omega \text{ typ.}(\text{at } V_{GS} = 4.5 \text{ V})$
- Low drive current
- High density mounting
- 2.5 V gate drive device

Outline



Absolute Maximum Ratings

Item	Symbol	Ratings	$\frac{(1a = 25^{\circ}C)}{\text{Unit}}$
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±12	V
Drain current	I _D	2.5	А
Drain peak current	Note1 I _{D (pulse)}	10	А
Body - drain diode reverse drain current	I _{DR}	2.5	А
Channel dissipation	Pch Note2	900	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 $\mu s,$ duty cycle \leq 1%

2. When using the glass epoxy board (FR4 40 x 40 x 1.6mm)



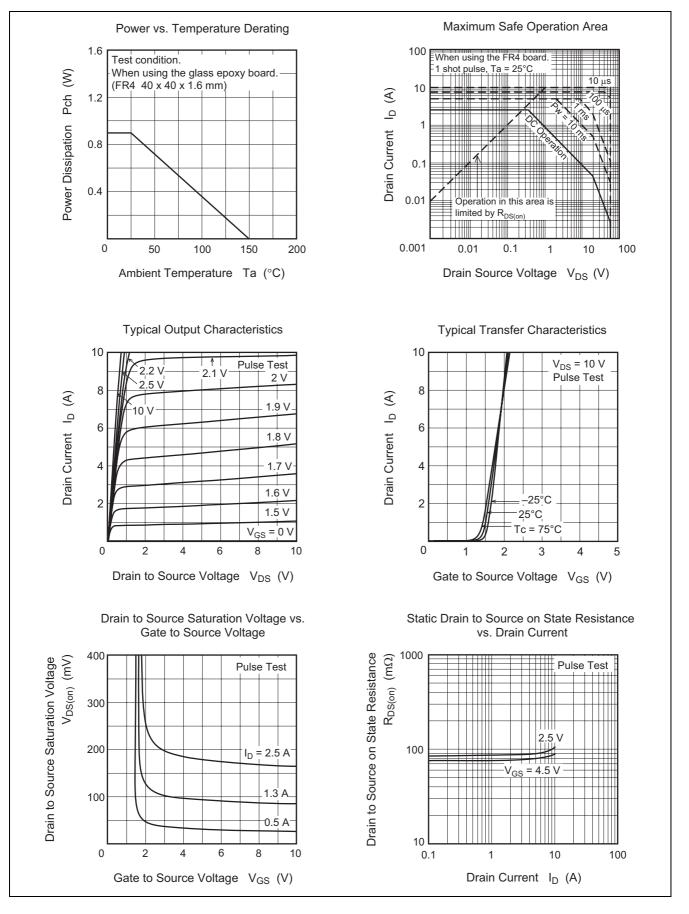
Electrical Characteristics

						$(Ta = 25^{\circ}C)$	
ltem	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to source breakdown voltage	V _{(BR)DSS}	60	_		V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to source breakdown voltage	V _{(BR)GSS}	±12				$I_G = \pm 100 \ \mu\text{A}, \ V_{\text{DS}} = 0$	
Gate to source leak current	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 10 \text{ V}, \text{ V}_{DS} = 0$	
Drain to source leak current	I _{DSS}	_	—	1	μA	$V_{DS} = 60 V, V_{GS} = 0$	
Gate to source cutoff voltage	V _{GS(off)}	0.4	_	1.4	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	
Drain to source on state resistance	R _{DS(on)}	_	75	98	mΩ	$I_D = 1.3 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note3}}$	
	R _{DS(on)}	_	85	119	mΩ	$I_D = 1.3 \text{ A}, V_{GS} = 2.5 \text{ V}^{\text{Note3}}$	
Forward transfer admittance	yfs	3.3	5		S	$I_D = 1.3 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$	
Input capacitance	Ciss	_	590		pF	$V_{DS} = 10 V, V_{GS} = 0,$	
Output capacitance	Coss	_	60		pF	f = 1 MHz	
Reverse transfer capacitance	Crss		35		pF		
Turn - on delay time	td(on)		17		ns	$I_{D} = 1.3 \text{ A}$ $V_{GS} = 4.5 \text{ V}, \text{ V}_{DD} = 10 \text{ V}$ $R_{L} = 7.7 \Omega, \text{ Rg} = 4.7 \Omega$	
Rise time	tr		50		ns		
Turn - off delay time	td(off)	_	41	_	ns		
Fall time	tf	_	4	_	ns		
Total gate charge	Qg	_	6	_	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	
Gate to source charge	Qgs	_	1.2	_	nC	I _D = 2.5 A	
Gate to drain charge	Qgd	_	1.4	_	nC		
Body - drain diode forward voltage	V _{DF}	_	0.8	1.1	V	$I_F = 2.5 \text{ A}, V_{GS} = 0^{Note3}$	

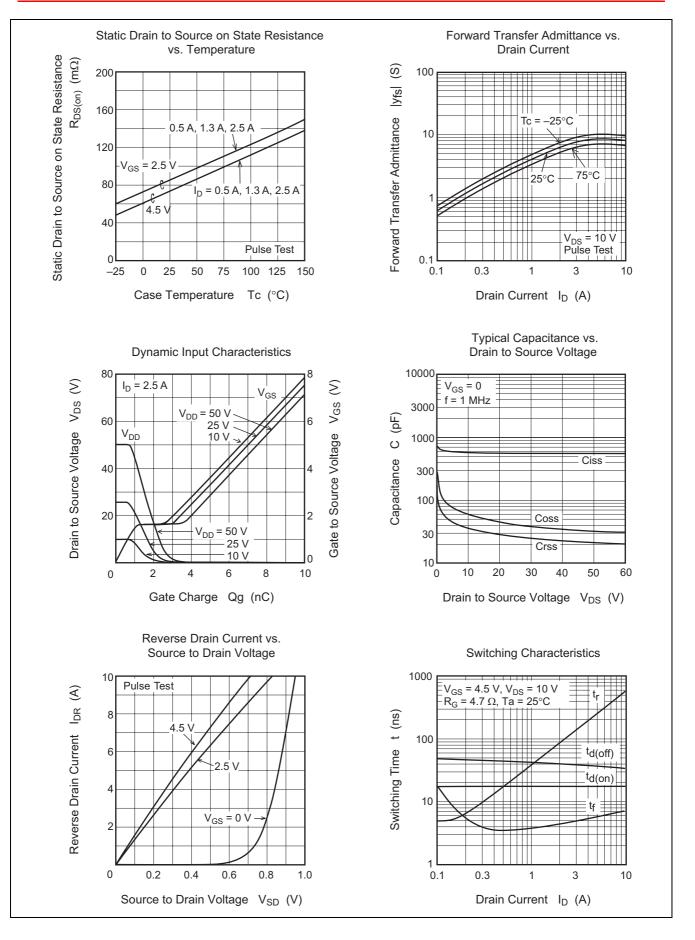
Notes: 3. Pulse test



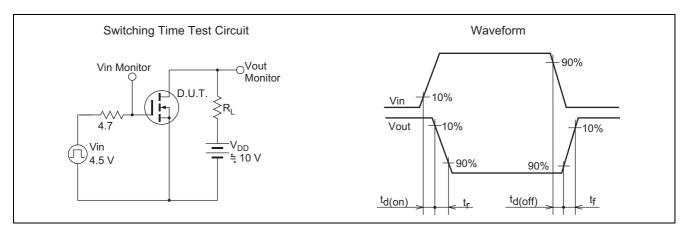
Main Characteristics





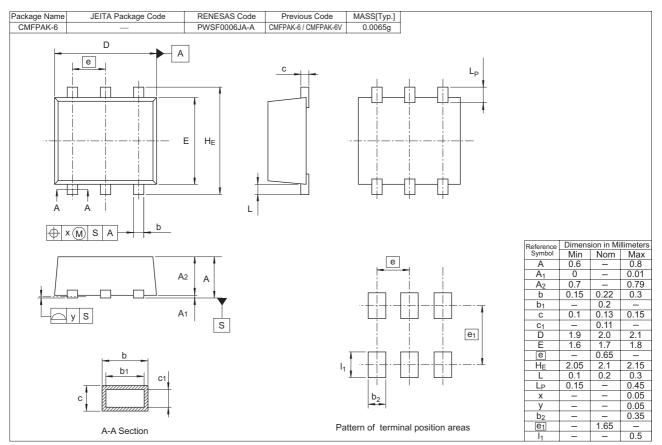








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
HAT2240C-EL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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